MASW20000

GaAs SPDT Switch DC - 20 GHz



M/A-COM Products Rev. V5

Features

- Very Broadband Performance
- Low Insertion Loss: 1.75 dB Typical @ 18 GHz
- High Isolation: 50 dB Typical @ 18 GHz
- Fast Switching Speed: 2 ns Typical
- Reflective Configuration
- Ultra Low DC Power Consumption
- Via Hole Grounding

Description

M/A-COM's MASW20000 is a versatile, high isolation SPDT switch. Designed on M/A-COM's mature 1-micron MESFET process, this parts is ideal for modules or other packaging for use in the Cellular, GPS, LAN and infrastructure markets.

Demonstrating performance up to 20 GHz, the MASW20000 will perform well in many types of applications within that range.

Ordering Information¹

Part Number	Package	
MASW20000	Die	

1. Die quantity varies.

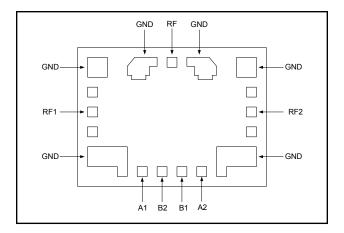
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Absolute Maximum Ratings²

Parameter	Absolute Maximum		
Control Voltage (A1/B2 or A2/B1)	-8.5 VDC		
Input RF Power	+34 dBm		
Operating Temperature	+175°C		
Storage Temperature	-65°C to +175°C		

2. Exceeding any one or combination of these limits may cause permanent damage to this device.

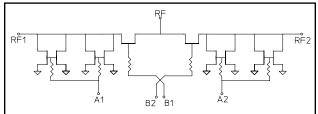
Pad Layout



Bond Pad Dimensions

Bond Pad	Dimension Inches (mm)		
RF, RF1, RF2	0.004 x 0.004 (0.100 x 0.100)		
A1, A2, B1, B2	0.004 x 0.004 (0.100 x 0.100)		
DIE Size	0.083 x 0.035 x 0.004 (2.10 x 0.89 x 0.10)		

Schematic



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Electrical Specifications³: $T_A = 25^{\circ}C$, $Z_0 = 50\Omega$, +25°C⁴

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Insertion Loss	10 GHz 18 GHz 20 GHz		—	1.4 1.75 2.0	1.7 2.1 2.5
Isolation	10 GHz 18 GHz 20 GHz		50 42 40	59 49 47	
VSWR	10 GHz 18 GHz 20 GHz				1.6:1 1.8:1 2.0:1
Trise, Tfall	10% to 90% RF and 90% to 10% RF	ns	_	2	—
Ton, Toff	50% control to 90% RF, and 50% control to 10% RF	ns		3	
Transients	In-Band	mV	_	20	_
Input P1dB	0.5 - 20 GHz, 0 to -5 V 0.05 GHz, 0 to -5 V	dBm dBm	_	25 18	
IP2	Two Tone, +5 dBm/Tone, 5 MHz Spacing, >50 MHz 0.5 - 20 GHz	dBm	_	+59	_
IIP3	Two Tone, +5 dBm/Tone, 5 MHz Spacing, >50 MHz 0.5 - 20 GHz 0.05 GHz		_	+43 +27	_
Control Voltage (Complementary Logic)	V _{IN} Low, 0 to -0.2 V V _{IN} High, -5 V	μΑ μΑ	_	_	5 50

3. All specifications apply with 50 Ω impedance connected to all RF ports, 0 and –5 VDC control voltages.

4. Loss changes 0.0025 dB/°C (From -55°C to +85°C).

Truth Table 5,6

Control Inputs		Condition of Switch	
A1/B2	A2/B1	RF1	RF2
V _{IN} Hi	V _{IN} Low	On	Off
V _{IN} Low	V _{IN} Hi	Off	On

5. V_{IN} Low = 0 to -0.2 V, V_{IN} Hi = -5V

6. For normal SPDT operation A1 is connected to B2 and A2 is connected to B1.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

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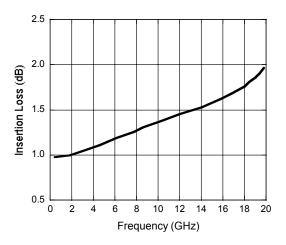
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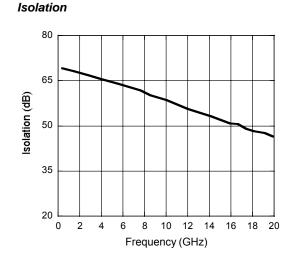
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E Tyco Electronics

Typical Performance Curves

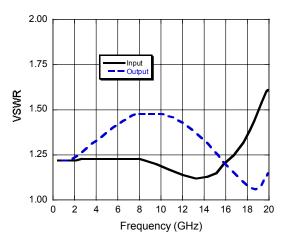
Insertion Loss





VSWR

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Handling Procedures

Permanent damage to the MASW20000 may occur if the following precautions are not adhered to:

- A. Cleanliness The MASW20000 should be handled in a clean environment. DO NOT attempt to clean assembly after the MASW20000 is installed.
- B. Static Sensitivity All die handling equipment and personnel should be DC grounded.
- C. Transients Avoid instrument and power supply transients while bias is connected to the MASW20000. Use shielded signal and bias cables to minimize inductive pick-up.
- D. Bias Apply voltage to either control port A1/B2 or A2/B1 only when the other is grounded. Neither port should be allowed to "float".
- E. General Handling It is recommended that the MASW20000 chip be handled along the long side of the die with a sharp pair of bent tweezers. DO NOT touch the surface of the chip with fingers or tweezers.

Mounting

The MASW20000 is back-metallized with Pd/Ni/Au (100/1,000/30,000Å) metallization. It can be die-mounted using Au/Sn eutectic preforms or a thermally conductive epoxy. The package surface should be clean and flat before attachment.

Eutectic Die Attach:

- A. An 80/20 Au/Sn preform is recommended with a work surface temperature of approximately 255°C and a tool temperature of 265°C. When hot 90/10 nitrogen/hydrogen gas is applied, solder temperature should be approximately 290°C.
- B. DO NOT expose the MASW20000 to a temperature greater than 320°C for more than 20 seconds. No more than 3 seconds of scrubbing should be required for attachment.

Epoxy Die Attach:

- A. Apply a minimum amount of epoxy and place the MASW20000 into position. A thin epoxy fillet should be visible around the perimeter of the die.
- B. Cure epoxy per manufacturer's recommended schedule.
- C. Electrically conductive epoxy is recommended but is not required.

Wire Bonding

- A. Ball or wedge bond with 1.0 mil diameter pure gold wire. Gold ribbon (3.0 mil x 0.5 mil) may also be used. Thermo sonic wire bonding with a nominal stage temperature of 150°C and a ball bonding force of 40 to 50 grams or wedge bonding force of 18 to 22 grams is recommended. Ultrasonic energy and time should be adjusted to the minimum levels to achieve reliable wirebonds.
- B. Wirebonds should be started on the chip and terminated on the package.

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